Insulation Resistance: 500M Ω min. at 500V DC Withstanding Voltage: 250V ACrms for 1 minute

Contact Resistance: $100m\Omega$ max. at 10mA/20mV max.

Current Rating: Voltage Rating. 5.0Vrms -55°C to +85°C Operating Temp. Range: 5,000 insertions Mating Cycles:



Insulator: LCP, glass filled (UL94V-0) Contact Plating: Mating Face - Gold over Nickel

Solder Tails - Gold over Nickel

Features

- Conforms to GSM11.11 standard for the European mobile phone system
- Smooth extraction function by Push / Push mechanism

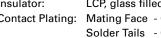
Part Number (Details)

FMS006Z - 2000 - 0

without Switch

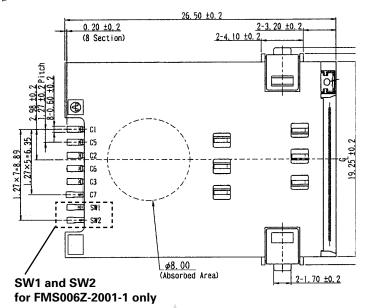
FMS006Z - 2001 - 1

with Switch



- With and without switch
- For assembly on top of the PC-Board ■ Tape and Reel Packaging (800 pcs./reel)

Outline Connector Dimensions for FMS006Z-200*-*

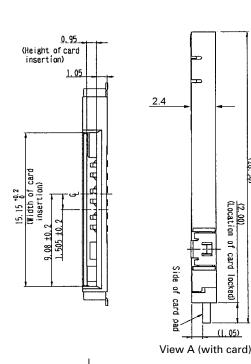


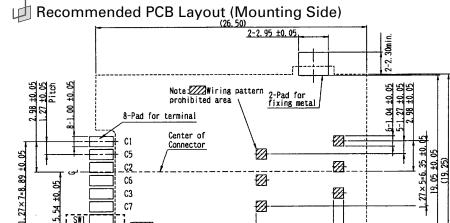
View A

C7

SWI

SW2

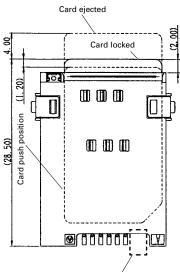




Outer dimension

Connector

Ø



Card Insertion

For FMS006Z-2001-1 only

8-2.30min

6-1,00 ±0,05